

# Honorary co-Chair:

Mohamed Elmasry, Waterloo Univ., Canada

#### Conference co-Chairs:

Mohamad Sawan, Westlake Univ., China

Yehea Ismail, AUC, Egypt

#### Technical Program co-Chairs:

Ahmed Madian, IEEE CAS, Egypt

Adnan Harb, LIU, Lebanon

Abdallah Kassem, NDU, Lebanon

Fouad Hajj Hassan, AlMaaref, Univ., Lebanon

### **Publication co-Chairs:**

Mohamed Tabaa, EMSI, Morocco Sofiene Tahar, Concordia Univ., Canada

Finance co-Chairs:

Raafat Lababidi, Ensta, France

#### **Publicity co-Chairs**

Raafat Lababidi, Ensta, France

Mohamed Abid, Tunisia

### **Special Session co-Chairs:**

Tales Pimenta, UFI, Brazil

Vassilis Alimisis, NTUA, Greece

Ahmad Kobeissi, LIU, Lebanon Majd Saied, LIU, Lebanon

**Industrial Relation Chairs:** 

Rabih Rammal, LIU, Lebanon

Ali M. Haidar, BAU, Lebanon

Xiaojin Zhao, Shenzhen University, China

# **Local Arrangement co-Chairs:**

Abdallah Kassem, NDU, Lebanon

Ahmed Madian, IEEE CAS, Egypt **Tutorials co-Chairs** 

# Mourad Loulou, NES, Tunisia

Hani Saleh, KU, UAE

Ali M. Haidar, BAU, Lebanon

Ahmad Diab, LIU, Lebanon

## International Coordinators

Abbas Dandache, LU, France

Abdoul Rjoub, JUST, Jordan Ahmed Bouridane, UAE

Ameena Al-Sumaiti, KU, UAE

Baker Mohammad, KU, UAE

Khaled Salama, KAUST, KSA

Maitham Shams, Carleton University, Canada

Mehdi Ehsanian-Mofrad, KNTU, Iran

Mohamad Abou Ali, Spain

Mohamed Masmoudi, ENIS, Tunisia Mohammed Ismail, W.S.U, USA

Mounir Boukadoum UQAM, Canada

Mourad Loulou. Tunisia

Nabil Karami, UCT, UAE

Nabil Khachab, Kuwait University, Kuwait

Omar FALOU, Canada

Otmane Ait Mohamed, Concordia Univ, Canada

Raafat Lababidi, Ensta, France

Said Elnaffar, CUD, UAE

Tales Pimenta, UFI, Brazil



COMPUTER IE13/PE31/CAS04/PEL3 Lebanon Chapter

The International Conference on Microelectronics has already been held numerous times in different countries across the Middle East, Southern Europe, and Asia for the past 36 years. The 37<sup>th</sup> edition of the conference will take place in Cairo, Egypt. ICM 2025 will include oral, poster sessions and tutorials given by experts on state-of-the-art topics. The regular technical program will run for three days. In addition, tutorial sessions will be held

on the latest developments in circuits and systems research. As such, the conference is primarily aimed at researchers, academics, engineers, and professionals in the field of circuits and systems. The conference, spanning over four days, will include peer-reviewed paper submissions, and accepted papers will be considered for inclusion in IEEE Xplore.

on the first day of the conference. ICM 2025 is a highly technical conference that focuses

Papers are solicited in but not limited to the following tonics:

۰	apers are sometically but not immeditely the following topics:
	$\hfill\Box$ Circuits and Systems $\hfill\Box$ Digital signal and data processing $\hfill\Box$ AI $\hfill\Box$ IoT and Wireless
	communication systems □ Analog and RF circuit design techniques □ Nonlinear circuits
	$\ \square$ VLSI for signal and image processing $\ \square$ System on chip (SoCs) $\ \square$ Integrated antenna
	and front-end co-design $\Box$ IoT circuits and security $\Box$ Metaverse and Sensors $\Box$
	Biomedical circuits and systems $\ \square$ CAD Tools and Design $\ \square$ Simulation (process, device,
	circuit, logic, timing, function) $\square$ Silicon optimization $\square$ Parallel embedded systems $\square$
	Testing: Formal verification $\square$ CAD for FPGAs $\square$ High-level synthesis tools $\square$ Design for
	testability $\square$ Micro/Nanoelectronics $\square$ Device characterization and modelling $\square$ Device
	physics and novel structures $\Box$ Process technology, CMOS, BJT, BiCMOS, GaAs $\Box$
	Reliability and failure analysis $\square$ Optoelectronics $\square$ MEMS devices $\square$ Packaging and
	surface mount technology

## **Paper Submission**

Authors are invited to submit papers in PDF using according to IEEE formatting guidelines. Paper template could be downloaded from the following website: https://www.ieee.org/conferences\_events/conferences/publishing/templates.html Electronic submission of papers should be done via EDAS:

# https://edas.info/newPaper.php?c=33298

Questions regarding submission should be directed to <a href="info@ieee-icm.org">info@ieee-icm.org</a>

Accepted and presented papers for authors who complete registration will be submitted for inclusion to IEEE Xplore.

## **Review Process**

The evaluation of submitted papers is based on the importance and usefulness of the research topic. Technical merits, novelty of the approach, soundness of results, and clarity of presentation are also considered as factors of the evaluation process. Each paper will be fully reviewed by a minimum of Three specialized reviewers.

# **Important Dates:**

Camera Ready

**Full Paper Submission Paper's Notification** 

**Submission of Special Sessions Proposals** 

**Submission of Tutorials Proposals** 

**Notification of Tutorials Proposals Acceptance** 

**Notification of Special Sessions Proposals Acceptance** 

: September 29<sup>th</sup>, 2025 : October 27<sup>th</sup>, 2025

: November 19<sup>th</sup>, 2025

: September 25<sup>th</sup>, 2025

: September 25<sup>th</sup>, 2025

: September 30<sup>th</sup>, 2025

: September 30<sup>th</sup>, 2025

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